

N-channel 40 V, 0.7 mΩ standard level MOSFET in LFPAK88 2 May 2019 Product data sheet

1. General description

Automotive qualified N-channel MOSFET using the latest Trench 9 low ohmic superjunction technology, housed in a copper-clip LFPAK88 package. This product has been fully designed and qualified to meet beyond AEC-Q101 requirements delivering high performance and reliability.

2. Features and benefits

- Fully automotive qualified to beyond AEC-Q101:
- -55 °C to +175 °C rating suitable for thermally demanding environments
- LFPAK88 package:
 - Designed for smaller footprint and improved power density over older wire bond packages such as D²PAK for today's space constrained high power automotive applications
 - Thin package and copper clip enables LFPAK88 to be highly efficient thermally
- LFPAK copper clip technology enabling improvements over wire bond packages by:
 - Increased maximum current capability and excellent current spreading
 - Improved R_{DSon}
 - Low source inductance
 - Low thermal resistance R_{th}
- LFPAK Gull Wing leads:
 - Flexible leads enabling high Board Level Reliability absorbing mechanical and thermal cycling stress, unlike traditional QFN packages
 - · Visual (AOI) soldering inspection, no need for expensive x-ray equipment
 - Easy solder wetting for good mechanical solder joint
- Unique 40 V Trench 9 superjunction technology:
 - Reduced cell pitch and superjunction platform enables lower R_{DSon} in the same footprint
 - Improved SOA and avalanche capability compared to standard TrenchMOS
 - Tight V_{GS(th)} limits enable easy paralleling of MOSFETs

3. Applications

- 12 V automotive systems
- 48 V DC/DC systems (on 12 V secondary side)
- Higher power motors, lamps and solenoid control
- Reverse polarity protection
- LED lighting
- Ultra high performance power switching

4. Quick reference data

Table 1. Quick reference data								
Symbol	Parameter	Conditions		Min	Тур	Мах	Unit	
V _{DS}	drain-source voltage	25 °C ≤ T _j ≤ 175 °C		-	-	40	V	
I _D	drain current	V _{GS} = 10 V; T _{mb} = 25 °C; <u>Fig. 2</u>	[1]	-	-	425	А	
P _{tot}	total power dissipation	T _{mb} = 25 °C; <u>Fig. 1</u>		-	-	375	W	

ne<mark>x</mark>peria

Symbol	Parameter	Conditions		Min	Тур	Max	Unit	
Tj	junction temperature			-55	-	175	°C	
Static characte	Static characteristics							
R _{DSon}	drain-source on-state resistance	V _{GS} = 10 V; I _D = 25 A; T _j = 25 °C; <u>Fig. 11</u>		0.43	0.62	0.7	mΩ	
Dynamic characteristics								
Q _{GD}	gate-drain charge	I _D = 25 A; V _{DS} = 32 V; V _{GS} = 10 V; <u>Fig. 13; Fig. 14</u>		-	25	50	nC	
Source-drain diode								
Q _r	recovered charge	I_{S} = 25 A; dI_{S}/dt = -100 A/µs; V_{GS} = 0 V; V_{DS} = 20 V	[2]	-	74	-	nC	

425A continuous current has been successfully demonstrated during application. practically the current will be limited by PCB, thermal [1] design and operating temperature.

[2] includes capacitive recovery

5. Pinning information

Table 2. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	G	gate		D
2	S	source		
3	S	source	0	G-UF
4	S	source		mbb076 S
mb	D	mounting base; connected to drain		

6. Ordering information

Table 3. Ordering information							
Type number	Package						
	Name	Description	Version				
BUK7S0R7-40H	LFPAK88	plastic, single-ended surface-mounted package (LFPAK88); 4 leads; 2 mm pitch; 8 mm x 8 mm x 1.6 mm body	SOT1235				

7. Marking

Table 4. Marking codes					
Type number	Marking code				
BUK7S0R7-40H	7S0R740H				

8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V _{DS}	drain-source voltage	25 °C ≤ T _j ≤ 175 °C	-	40	V

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Symbol	Parameter	Conditions		Min	Max	Unit			
V _{GS}	gate-source voltage	DC; T _j ≤ 175 °C		-10	20	V			
P _{tot}	total power dissipation	T _{mb} = 25 °C; <u>Fig. 1</u>		-	375	W			
I _D	drain current	V _{GS} = 10 V; T _{mb} = 25 °C; <u>Fig. 2</u>	[1]	-	425	A			
I _{DM}	peak drain current	pulsed; $t_p \le 10 \ \mu s$; $T_{mb} = 25 \ ^{\circ}C$; Fig. 3		-	1983	A			
T _{stg}	storage temperature			-55	175	°C			
Tj	junction temperature			-55	175	°C			
Source-drain die	ode								
I _S	source current	T _{mb} = 25 °C	[2]	-	500	A			
I _{SM}	peak source current	pulsed; $t_p \le 10 \ \mu s$; $T_{mb} = 25 \ ^{\circ}C$		-	1983	A			
Avalanche rugg	Avalanche ruggedness								
E _{DS(AL)S}	non-repetitive drain- source avalanche energy	I _D = 120 A; V _{sup} ≤ 40 V; R _{GS} = 50 Ω; V _{GS} = 10 V; T _{j(init)} = 25 °C; unclamped; Fig. 4	[3] [4]	-	940	mJ			

425A continuous current has been successfully demonstrated during application. practically the current will be limited by PCB, thermal [1] design and operating temperature.

500A continuous current has been successfully demonstrated during application. practically the current will be limited by PCB, thermal [2] design and operating temperature.

Single-pulse avalanche rating limited by maximum junction temperature of 175 °C. [3]

Refer to application note AN10273 for further information. [4]





the current will be limited by PCB, thermal design and operating temperature.

Continuous drain current as a function of Fig. 2. mounting base temperature



9. Thermal characteristics

Table 6. Thermal characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
R _{th(j-mb)}	thermal resistance from junction to mounting base	<u>Fig. 5</u>	-	0.35	0.4	K/W

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10. Characteristics

Table 7. Cha	able 7. Characteristics								
Symbol	Parameter	Conditions	Min	Тур	Max	Unit			
Static chara	acteristics								
V _{(BR)DSS}	drain-source	I _D = 250 μA; V _{GS} = 0 V; T _j = 25 °C	40	43	-	V			
	breakdown voltage	I _D = 250 μA; V _{GS} = 0 V; T _j = -40 °C	-	40.5	-	V			
		I _D = 250 μA; V _{GS} = 0 V; T _j = -55 °C	36	40	-	V			
V _{GS(th)}	gate-source threshold voltage	$I_D = 1 \text{ mA}; V_{DS}=V_{GS}; T_j = 25 \text{ °C}; Fig. 9;$ Fig. 10	2.4	3	3.6	V			
		I _D = 1 mA; V _{DS} =V _{GS} ; T _j = -55 °C	-	-	4.3	V			
		I _D = 1 mA; V _{DS} =V _{GS} ; T _j = 175 °C	1	-	-	V			
I _{DSS}	drain leakage current	V _{DS} = 40 V; V _{GS} = 0 V; T _j = 25 °C	-	0.86	2.3	μA			
		V _{DS} = 16 V; V _{GS} = 0 V; T _j = 125 °C	-	10	25	μA			
		V _{DS} = 40 V; V _{GS} = 0 V; T _j = 175 °C	-	614	1500	μA			
I _{GSS}	gate leakage current	V _{GS} = 20 V; V _{DS} = 0 V; T _j = 25 °C	-	2	100	nA			
		V _{GS} = -10 V; V _{DS} = 0 V; T _j = 25 °C	-	2	100	nA			
R _{DSon}	drain-source on-state resistance	V _{GS} = 10 V; I _D = 25 A; T _j = 25 °C; Fig. 11	0.43	0.62	0.7	mΩ			
		V _{GS} = 10 V; I _D = 25 A; T _j = 105 °C; <u>Fig. 12</u>	0.61	0.9	1.11	mΩ			
		V _{GS} = 10 V; I _D = 25 A; T _j = 125 °C; Fig. 12	0.68	1	1.23	mΩ			
		V _{GS} = 10 V; I _D = 25 A; T _j = 175 °C; <u>Fig. 12</u>	0.85	1.23	1.53	mΩ			
R _G	gate resistance	f = 1 MHz; T _j = 25 °C	0.5	1.2	3	Ω			
Dynamic ch	aracteristics								
Q _{G(tot)}	total gate charge	$I_D = 25 \text{ A}; V_{DS} = 32 \text{ V}; V_{GS} = 10 \text{ V};$	-	144	202	nC			
Q _{GS}	gate-source charge	_ <u>Fig. 13;</u> <u>Fig. 14</u>	-	40	60	nC			
Q _{GD}	gate-drain charge] [-	25	50	nC			
				-	-				

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Symbol	Parameter	Conditions		Min	Тур	Max	Unit
C _{iss}	input capacitance	V _{DS} = 25 V; V _{GS} = 0 V; f = 1 MHz;		-	11228	15719	pF
C _{oss}	output capacitance	T _j = 25 °C; <u>Fig. 15</u>		-	2363	3308	pF
C _{rss}	reverse transfer capacitance			-	415	913	pF
t _{d(on)}	turn-on delay time	V_{DS} = 30 V; R _L = 1.2 Ω; V _{GS} = 10 V;		-	35	-	ns
t _r	rise time	$R_{G(ext)} = 5 \Omega$		-	30	-	ns
t _{d(off)}	turn-off delay time	-		-	94	-	ns
t _f	fall time			-	41	-	ns
Source-dra	in diode					_	
V _{SD}	source-drain voltage	I _S = 25 A; V _{GS} = 0 V; T _j = 25 °C; <u>Fig. 16</u>		-	0.75	1	V
t _{rr}	reverse recovery time	$I_{S} = 25 \text{ A}; \text{ dI}_{S}/\text{dt} = -100 \text{ A}/\mu\text{s}; \text{ V}_{GS} = 0 \text{ V};$		-	53	-	ns
Q _r	recovered charge	V _{DS} = 20 V	[1]	-	74	-	nC
S	softness factor	$I_{S} = 25 \text{ A}; \text{ d}I_{S}/\text{d}t = -100 \text{ A}/\mu\text{s}; \text{ V}_{GS} = 0 \text{ V}; \\ \text{V}_{DS} = 20 \text{ V}; \text{ T}_{j} = 25 ^{\circ}\text{C}$		-	0.79	-	
		I _S = 25 A; dI _S /dt = -500 A/µs; V _{GS} = 0 V; V _{DS} = 20 V; T _i = 25 °C		-	0.73	-	

[1] includes capacitive recovery



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BUK7S0R7-40H



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11. Package outline



12. Soldering



13. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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